



Youth Scholarship Program 2009

For children and grandchildren of TIMEC Company Inc., TIMEC Constructors, Welltech,
World Wide Welding and James TIMEC Company employees

Student Application

(Photocopies accepted)

Please type or clearly print all information. Form must be filled out completely and signed.

TIMEC EMPLOYEE INFORMATION

Name of employee: _____

Name of company: _____

Mailing address: _____

APPLICANT INFORMATION

Name of applicant: _____

Mailing address: _____

Telephone number: _____

High school name and address: _____

College or university name and address, if currently attending or applying
to: _____

School telephone number: _____

ACADEMIC INFORMATION

High school grade point average: _____

ACT or SAT score: _____

Year graduating or graduated high school: _____

Year expected to graduate college or university: _____

PARENT, GRANDPARENT OR GUARDIAN INFORMATION:

Name and address of company
employee _____

HONORS AND ACTIVITIES

Please briefly outline academic prizes, awards, extracurricular school activities, non-school
activities, community service and hobbies:

WRITING SAMPLE/ESSAY

On a separate sheet of paper, write a 500-750 word essay that explains why you feel you should be awarded this scholarship. Please be original, creative and use proper grammar and punctuation. (Only writing samples that are typed or printed will be considered).

ATTACHMENTS

Please submit the following materials:

- Completed and signed application
- Essay
- Copy of ACT scores or verification
- Proof of GPA
- Proof of high school enrollment
- Proof of acceptance to an accredited college or university

TERMS OF APPLICATION

Applicants who submit this form and meet the appropriate requirements agree to the following:

1. All prizewinners will be notified in writing.
2. All applicants and writing samples become the property of TIMEC Company Inc.
3. I verify to the best of my knowledge that all the information contained in this application is accurate and correct. My parent or guardian has signed the application verifying the accuracy of the information contained within.
4. I agree to the terms and conditions of TIMEC Company Inc. to verify all aspects of this application with any high school, college or university. I agree to abide by all the terms and conditions of the TIMEC Company, Inc. Youth Scholarship Program rules.

Signature of student	Date
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Signature of parent or guardian	Date
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Mail application and attachments to:

TIMEC Company, Inc.
Youth Scholarship Program
155 Corporate Place
Vallejo, CA 94590
Attn: Bonnie Morgan

Deadline for applications: Must be postmarked by: May 31st, 2009
Questions? Contact Bonnie Morgan at the Vallejo, Calif. office, 800-99-TIMEC #7015